TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

TC74LCX240F, TC74LCX240FT, TC74LCX240FK

Low-Voltage Octal Bus Buffer (inverted) with 5-V Tolerant Inputs and Outputs

The TC74LCX240 is a high-performance CMOS octal bus buffer. Designed for use in 3.3-V systems, it achieves high-speed operation while maintaining the CMOS low power dissipation.

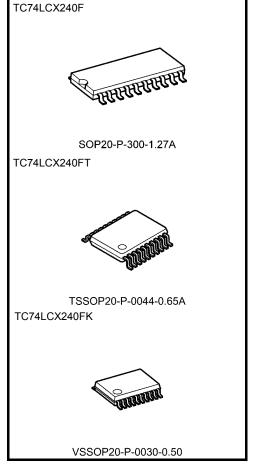
The device is designed for low-voltage (3.3 V) VCC applications, but it could be used to interface to 5-V supply environment for both inputs and outputs.

The 74LCX240F/FT is an inverting 3-state buffer having two active-low output enables. This device is designed to be used with 3-state memory address drivers, etc.

All inputs are equipped with protection circuits against static discharge.

Features

- Low-voltage operation: VCC = 1.65 to 3.6 V
- High-speed operation: $t_{pd} = 6.5 \text{ ns (max) (V}_{CC} = 3.0 \text{ to } 3.6 \text{ V)}$
- Ouput current: $|I_{OH}|/I_{OL} = 24 \text{ mA (min) (V}_{CC} = 3.0 \text{ V)}$
- Latch-up performance: $> \pm 500 \text{ mA}$
- Available in JEITA SOP, TSSOP and VSSOP (US)
- · Power-down protection provided on all inputs and outputs
- Pin and function compatible with the 74 series (74AC/VHC/HC/F/ALS/LS etc.) 240 type



Weight

SOP20-P-300-1.27A : 0.22 g (typ.) TSSOP20-P-0044-0.65A : 0.08 g (typ.) VSSOP20-P-0030-0.50 : 0.03 g (typ.)

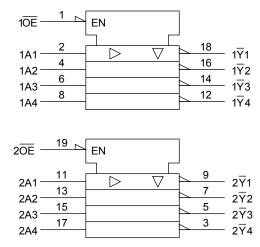
Note: The Electrical Characteristics of $V_{CC}=1.8\pm0.15V$ is only applicable for products which manufactured from January 2009 onward.

Start of commercial production 1994-03

Pin Assignment (top view)

10E 20 V_{CC} 1A1 19 2OE 2<u>7</u>4 1<u>Y</u>1 18 1A2 2A4 $1\overline{Y}2$ 2<u>7</u>3 16 1A3 2A3 $2\overline{Y}2$ 14 1<u>Y</u>3 1A4 13 2A2 2<u>7</u>1 1<u>Y</u>4 9 12 GND 2A1 10

IEC Logic Symbol



Truth Table

Inputs		Outputs
ŌĒ	An	Outputs
L	L	Н
L	Н	L
Н	Х	Z

X: Don't care

Z: High impedance

Absolute Maximum Ratings (Note 1)

Characteristics	Symbol	Rating	Unit
Power supply voltage	V _{CC}	-0.5 to 7.0	V
DC input voltage	V _{IN}	−0.5 to 7.0	V
		-0.5 to 7.0 (Note 2)	
DC output voltage	Vouт	-0.5 to V _{CC} + 0.5 (Note 3)	V
Input diode current	lık	-50	mA
Output diode current	lok	±50 (Note 4)	mA
DC output current	lout	±50	mA
Power dissipation	P _D	180	mW
DC V _{CC} /ground current	I _{CC} /I _{GND}	±100	mA
Storage temperature	T _{stg}	-65 to 150	°C

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2: Output in OFF state

Note 3: High or low state. IOUT absolute maximum rating must be observed.

Note 4: $V_{OUT} < GND, V_{OUT} > V_{CC}$



Operating Ranges (Note 1)

Characteristics	Symbol	Rating	Unit	
Power supply voltage	V _{CC}	1.65 to 3.6	V	
rower suppry voltage	v CC	1.5 to 3.6 (Note 2)	V	
Input voltage	V _{IN}	0 to 5.5	V	
Output voltage	V _{OUT}	0 to 5.5 (Note 3)	V	
Output Voltage		0 to V _{CC} (Note 4)		
Output current	I _{OH} /I _{OL}	±24 (Note 5)	mA	
Output current	IOH/IOL	±12 (Note 6)	ША	
Operating temperature	T _{opr}	-40 to 85	°C	
Input rise and fall time	dt/dv	0 to 10 (Note 7)	ns/V	

- Note 1: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either V_{CC} or GND.
- Note 2: Data retention only
 Note 3: Output in OFF state
 Note 4: High or low state
 Note 5: VCC = 3.0 to 3.6 V
- Note 5: $V_{CC} = 3.0 \text{ to } 3.6 \text{ V}$ Note 6: $V_{CC} = 2.7 \text{ to } 3.0 \text{ V}$
- Note 7: $V_{IN} = 0.8$ to 2.0 V, $V_{CC} = 3.0$ V



Electrical Characteristics

DC Characteristics ($Ta = -40 \text{ to } 85^{\circ}\text{C}$)

Characteristics		Symbol	Symbol Test Condition			Min	Max	Unit		
		-,	,		V _{CC} (V)					
H-level			_		1.65 to 2.3	V _{CC} × 0.9				
		V _{IH}			2.3 to 2.7	1.7	_			
Input voltage					2.7 to 3.6	2.0	_	V		
Input voltage					1.65 to 2.3	_	V _{CC} × 0.1	V		
	L-level	V_{IL}	_	-	2.3 to 2.7	_	0.7			
					2.7 to 3.6	_	8.0			
				$I_{OH} = -100 \mu A$	1.65 to 3.6	V _{CC} -0.2	_			
				I _{OH} = -4 mA	1.65	1.05	_			
	III Invest		M M ==M	I _{OH} = -8 mA	2.3	1.7		V		
	H-level	V _{OH}	$V_{IN} = V_{IH}$ or V_{IL}	I _{OH} = -12 mA	2.7	2.2				
				I _{OH} = -18 mA	3.0	2.4	_			
Output voltage				I _{OH} = -24 mA	3.0	2.2	_			
Catput Voltago			V _{IN} = V _{IH} or V _{IL}	I _{OL} = 100 μA	1.65 to 3.6	_	0.2			
		evel V _{OL} V _{IN}		$I_{OL} = 4 \text{ mA}$	1.65	_	0.45			
	L-level			$I_{OL} = 8 \text{ mA}$	2.3	_	0.7			
	L-level		VOL	VOL	VIN - VIH OI VIL	I _{OL} = 12 mA	2.7	_	0.4	
				I _{OL} = 16 mA	3.0	_	0.4			
						I _{OL} = 24 mA	3.0	_	0.55	
Input leakage current		I _{IN}	V _{IN} = 0 to 5.5 V		1.65 to 3.6	_	±5.0	μΑ		
3-state output OFF state current		I _{OZ}	V _{IN} = V _{IH} or V _{IL} V _{OUT} = 0 to 5.5 V		1.65 to 3.6	_	±5.0	μА		
Power-off leakage curr	ent	l _{OFF}	= V _{IN} /V _{OUT} = 5.5 V		0	_	10.0	μΑ		
Quiescent supply curre	Quiescent cumply current		V _{IN} = V _{CC} or GND		1.65 to 3.6	_	10.0			
Quicacent auppry curre	лц	Icc	V _{IN} /V _{OUT} = 3.6 to 5.5 V		1.65 to 3.6	_	±10.0	μΑ		
Increase in I _{CC} per inp	ut	Δlcc	$V_{IH} = V_{CC} - 0.6$	V	2.7 to 3.6	_	500			



AC Characteristics ($Ta = -40 \text{ to } 85^{\circ}\text{C}$)

Characteristics	Symbol	Test Condition		Min	Max	Unit
Sharastenisties	Cymbol	root condition	V _{CC} (V)		Wax	Oill
			1.8 ± 0.15	_	25.0	
Dranagation dalay time	t _{pLH}	Figure 1 Figure 2	2.5 ± 0.2	_	8.5	
Propagation delay time	t _{pHL}	Figure 1, Figure 2	2.7	_	7.5	ns
			3.3 ± 0.3	1.5	6.5	
			1.8 ± 0.15	_	32.0	ns
Output analyse times	^t pZL ^t pZH	Figure 1, Figure 3	2.5 ± 0.2	_	16.0	
Output enable time			2.7	_	9.0	
			3.3 ± 0.3	1.5	8.0	
			1.8 ± 0.15	_	30.0	
Output disable time	t _{pLZ} t _{pHZ}	Figure 1, Figure 3	2.5 ± 0.2	_	15.0	20
Output disable time			2.7	_	8.0	ns
			3.3 ± 0.3	1.5	7.0	
Output to output skew	t _{osLH}	(Nloto)	2.7	_	_	20
	t _{osHL}	(Note)	3.3 ± 0.3	_	1.0	ns

Note: Parameter guaranteed by design.

 $(t_{OSLH} = |t_{pLHm} - t_{pLHn}|, t_{OSHL} = |t_{pHLm} - t_{pHLn}|)$

Dynamic Switching Characteristics (Ta = 25°C, input: $t_r = t_f = 2.5$ ns, $C_L = 50$ pF, $R_L = 500$ Ω)

Characteristics	Symbol	Test Condition	V _{CC} (V)	Тур.	Unit
Quiet output maximum dynamic V _{OL}	V_{OLP}	$V_{IH} = 3.3 \text{ V}, V_{IL} = 0 \text{ V}$	3.3	8.0	V
Quiet output minimum dynamic V _{OL}	V _{OLV}	V _{IH} = 3.3 V, V _{IL} = 0 V	3.3	0.8	V

Capacitive Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	V _{CC} (V)	Тур.	Unit
Input capacitance	C _{IN}	_	3.3	7	pF
Output capacitance	C _{OUT}	_	3.3	8	pF
Power dissipation capacitance	C _{PD}	$f_{IN} = 10 \text{ MHz}$ (Note)	3.3	25	pF

Note: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption.

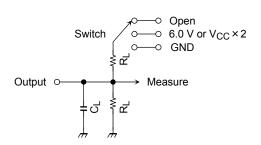
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Average operating current can be obtained by the equation:

 $I_{CC (opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/8 \text{ (per bit)}$



AC Test Circuit



Parameter	Switch		
t _{pLH} , t _{pHL}	Open		
	6.0 V	@ V _{CC} =3.3±0.3V	
t t		@ V _{CC} =2.7V	
^t pLZ, ^t pZL	V _{CC} ×2	@ V _{CC} =2.5±0.2V	
		@ V _{CC} =1.8±0.15V	
t _{pHZ} , t _{pZH}	GND		

Figuare 1



AC Waveform

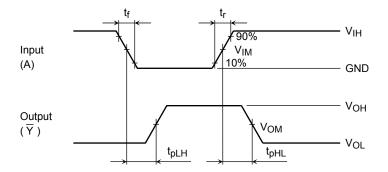


Figure 2 t_{pLH}, t_{pHL}

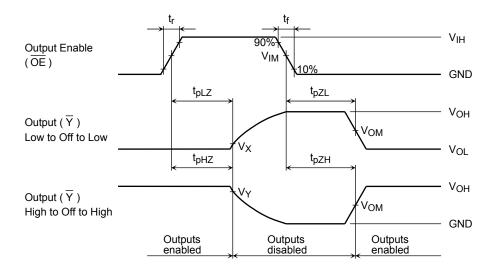


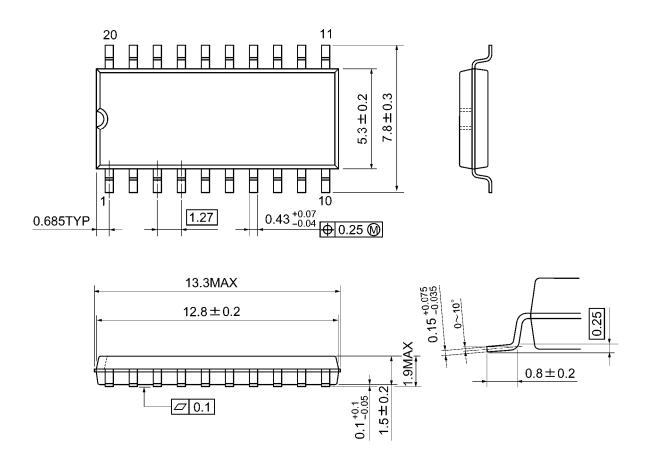
Figure 3 t_{pLZ} , t_{pHZ} , t_{pZL} , t_{pZH}

			Vcc	
	Symbol	$3.3 \pm 0.3 \text{ V}$ 2.7V	2.5 ± 0.2 V	1.8 ± 0.15 V
Input	V _{IH}	2.7V	V _{CC}	V _{CC}
	V _{IM}	1.5V	V _{CC} /2	V _{CC} /2
	t _r , t _f	2.5ns	2.0ns	2.0ns
Output	V _{OM}	1.5V	V _{OH} /2	V _{OH} /2
	VX	V _{OL} +0.3V	V _{OL} +0.15V	V _{OL} +0.15V
	VY	V _{OH} -0.3V	V _{OH} -0.15V	V _{OH} -0.15V
Load	CL	50pF	30pF	30pF
	RL	500Ω	500Ω	1kΩ



Package Dimensions

SOP20-P-300-1.27A Unit: mm



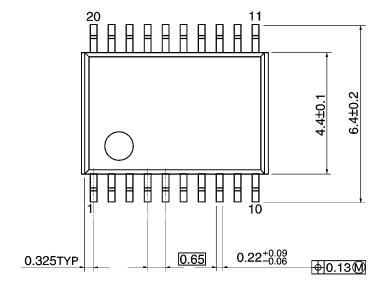
Weight: 0.22 g (typ.)

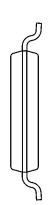


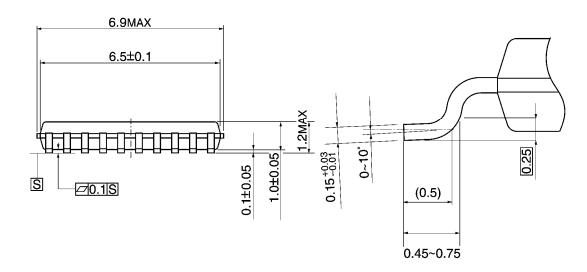
Package Dimensions

TSSOP20-P-0044-0.65A

Unit: mm



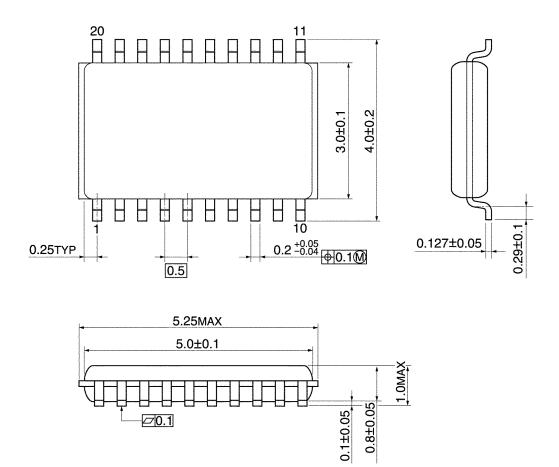




Weight: 0.08 g (typ.)

Package Dimensions

VSSOP20-P-0030-0.50 Unit: mm



Weight: 0.03 g (typ.)

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